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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/038,305	01/02/2002	Jigish D. Trivedi	MICRON.133DV1	7715
20995	7590 07/12/2004		EXAM	IINER
	MARTENS OLSON &	NGUYEN, THANH T		
	2040 MAIN STREET FOURTEENTH FLOOR		ART UNIT	PAPER NUMBER
IRVINE, CA 92614			2813	
			DATE MAILED: 07/12/2004	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)			
Advisory Action	10/038,305	TRIVEDI ET AL.			
	Examin r	Art Unit			
	Thanh T. Nguyen	2813			
The MAILING DATE of this communication appe	ears on the cover she t with the c	correspond nce address			
THE REPLY FILED 21 June 2004 FAILS TO PLACE THIS APPLICATION IN CONDITION FOR ALLOWANCE. Therefore, further action by the applicant is required to avoid abandonment of this application. A proper reply to a final rejection under 37 CFR 1.113 may only be either: (1) a timely filed amendment which places the application in condition for allowance; (2) a timely filed Notice of Appeal (with appeal fee); or (3) a timely filed Request for Continued Examination (RCE) in compliance with 37 CFR 1.114.					
PERIOD FOR REPLY [check either a) or b)]					
a) The period for reply expires 3 months from the mailing date of the final rejection. b) The period for reply expires on: (1) the mailing date of this Advisory Action, or (2) the date set forth in the final rejection, whichever is later. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of the final rejection. ONLY CHECK THIS BOX WHEN THE FIRST REPLY WAS FILED WITHIN TWO MONTHS OF THE FINAL REJECTION. See MPEP 706.07(f).  Extensions of time may be obtained under 37 CFR 1.136(a). The date on which the petition under 37 CFR 1.136(a) and the appropriate extension fee have been filed is the date for purposes of determining the period of extension and the corresponding amount of the fee. The appropriate extension fee under 37 CFR 1.17(a) is calculated from: (1) the expiration date of the shortened statutory period for reply originally set in the final Office action; or (2) as set forth in (b) above, if checked. Any reply received by the Office later than three months after the mailing date of the final rejection, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).					
1. A Notice of Appeal was filed on Appellant's Brief must be filed within the period set forth in 37 CFR 1.192(a), or any extension thereof (37 CFR 1.191(d)), to avoid dismissal of the appeal.					
2. The proposed amendment(s) will not be entered because:					
(a) ☐ they raise new issues that would require further consideration and/or search (see NOTE below);					
(b) ☐ they raise the issue of new matter (see Note below);					
(c) they are not deemed to place the application in better form for appeal by materially reducing or simplifying the issues for appeal; and/or					
(d) they present additional claims without canceling a corresponding number of finally rejected claims.					
NOTE:	-11 (-)				
3. Applicant's reply has overcome the following rejection.		congrato, timely filed amendment			
4. Newly proposed or amended claim(s) would be allowable if submitted in a separate, timely filed amendment canceling the non-allowable claim(s).					
5. ☐ The a) ☐ affidavit, b) ☐ exhibit, or c) ☐ request for reconsideration has been considered but does NOT place the application in condition for allowance because: See Continuation Sheet.					
6. The affidavit or exhibit will NOT be considered because it is not directed SOLELY to issues which were newly raised by the Examiner in the final rejection.					
7. For purposes of Appeal, the proposed amendment explanation of how the new or amended claims w	it(s) a)⊡ will not be entered or t rould be rejected is provided bel	o) will be entered and an ow or appended.			
The status of the claim(s) is (or will be) as follows	:				
Claim(s) allowed: NONE.					
Claim(s) objected to: NONE.					
Claim(s) rejected: 2-9 and 17-23.					
Claim(s) withdrawn from consideration: NONE.					
8. ☐ The drawing correction filed on is a) ☐ approved or b) ☐ disapproved by the Examiner.					
9. Note the attached Information Disclosure Statement(s)( PTO-1449) Paper No(s)					
10. Other:					
		Thanh T. Nguyen Examiner Art Unit: 2813			

Continuation of 5. does NOT place the application in condition for allowance because: Applicant contends that Havemann does not specifically teach filling the opening hole with the range about one third to two-third. In response to applicant that Havemann clearly teaches the limitation in figure 6C, col. 5, lines 39-41, 54-61 wherein filling the opening less than the height of the dielectric layer which interpretate as anywhere less than completely fill. see." In re Peterson, 315 F.3d 1325, 1330, 65 USPQ2d 1379, 1382-83 (Fed. Cir. 2003).

However, if the reference's disclosed range is so broad as to encompass a very large number of possible distinct compositions, this might present a situation analogous to the obviousness of a species when the prior art broadly discloses a genus. Id. See also In re Baird, 16 F.3d 380, 29 USPQ2d 1550 (Fed. Cir. 1994); In re Jones, 958 F.2d 347, 21 USPQ2d 1941 (Fed. Cir. 1992); MPEP § 2144.08. the piro referce that discloseds a reange encompassing a somewhat narrower claimed range is sufficient to establish a prima facie case of obviousness. therefore, the burden is shifted to the applicant to show side by side example of overlapping range as tuaght by HavemannI does not teach the unexpected result as the present invention teaches. Applicant also contends that Havemann does not teach filling the first conductive in the opening is less conductive than the second conductive layer in the opening. In response to applicant that Havemann teaches forming a first conductive layer (66, tungsten, see col. 3, lines 19-24) which is less conductive than the second conductive layer (70, aluminum, see col. 3, lines 19-21, and col. 6, lines 40-50). it is obvious that the first layer is tungsten and the second is aluminum because the process would raise contact floor allows more conductive metal to be deposited by less conformal deposition.